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By Nelia T. de Guzman Date July 15, 2005  
Nelia T. de Guzman

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PATENT  
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Inventor(s): Kong Weng Lee et al.

Group Art Unit: 2811

Serial No.: 10/608,606

Examiner: Shouxiang Hu

Filed: 27 June 2003

Title: *Method for Fabricating a Packaging Device for Semiconductor Die and Semiconductor Device Incorporating Same*

Atty Docket: 70030260-1

Entered  
w/ RCE  
8/8/05

AMENDMENT UNDER 37 CFR § 1.116

Commissioner for Patents  
P.O. Box 1450  
Alexandria  
VA 22313-1450

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Sir:

In response to the Official Action dated 18 May 2005, the applicants respectfully  
10 request entry of the following amendments:

2nd  
8/16/05

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